



# **Ultra High Light Output** QLUXR22330W100LED Series



Information Overview						
Wattage 50W						
Available CRI	80+/90+*					
Available CCT	2700-5000K					
Dimensions	228mm (OD)					
Number of LEDs	100					
Beam Angle 120						



### **FEATURES**

- High Color Renedering Index (CRI) Ra max. 98
- High efficacy lumen output
- LM-80 compliant LEDs
- Tight Binning 3 Step Mac Adam Ellipses
- Uniform & Crisp Light Source Intensity
- Hot Spot Free Design
- Exceed ENERGY STAR lumen maintenance requirements
- Extra thin low profile
- Low heat generation, easy thermal management
- Easy to fit in new design or retrofit applications

## **APPLICATIONS**

For Architectural New Designs and Retrofits lighting fixtures:

**Indoor Lightings:** 

- Recessed can light
- Ceiling light
- Wall sconces
- Table lamps
- Fixtures
- Signage

Outdoor Lightings:

- Street light
- Marker lights
- Wall sconces
- Signage lights

### ELECTRICAL SPECS.

50W Round	Wattage	Forward Voltage			Forward Current		
<b>Model Number</b>	Max.	Тур.	Vf Min.	Vf Max.	Тур.	Max.	
QLUXR22330W100LED	50W	30V	28V	33V	1000mA	1500mA	

Order Number	CRI	ССТ
QLUXR22330W100LED22K8CR	80+	2200K
QLUXR22330W100LED25K8CR	80+	2500K
QLUXR22330W100LED27K8CR	80+	2700K
QLUXR22330W100LED30K8CR	80+	3000K
QLUXR22330W100LED32K8CR	80+	3200K
QLUXR22330W100LED35K8CR	80+	3500K
QLUXR22330W100LED40K8CR	80+	4000K
QLUXR22330W100LED50K8CR	80+	5000K

Order Number	CRI	ССТ
QLUXR22330W100LED22K9CR	90+	2200K
QLUXR22330W100LED25K9CR	90+	2500K
QLUXR22330W100LED27K9CR	90+	2700K
QLUXR22330W100LED30K9CR	90+	3000K
QLUXR22330W100LED32K9CR	90+	3200K
QLUXR22330W100LED35K9CR	90+	3500K
QLUXR22330W100LED40K9CR	90+	4000K
QLUXR22330W100LED50K9CR	90+	5000K

\* Up to 98 CRI





## **ELECTRICAL SPECIFICATIONS - 80 CRI**

Absolute Maximum Ratings (Ta=25C, RH30%)			
Parameter	Symbol	Rating	Unit
DC Input Forward Current *	I <sub>IN</sub>	1500	mA
Power Dissipation	$P_{D}$	50	W
Junction Temperature*	Tj	125	°C
Operating Temperature	Topr	-20 ~ +50	°C
ESD	НВМ	5000	V
Storage Temperature	Tstg	-40 ~ +80	°C
Temperature of AI MCPCB** Max.	TS	85	°C

ctrical & Optical Characte	ristics (Ta=25	SC, RH30%)					
Parameter	Symbol	Condition	Model	Min.	Тур.	Max.	Unit
Forward Voltage*	VF	I <sub>F</sub> = 1000 mA		28	30	33	V
			2700K		3750		
			3000K		3900		
Total Flux	ФV	I <sub>F</sub> = 1000 mA	3500K		4050		lm
			4000K		4200		
			5000K		4500		
Efficacy			2700K		125		
		η I <sub>F</sub> = 1000 mA	3000K		130		lm/W
	η		3500K		135		
			4000K		140		
			5000K		150		
			2700K		2700		
			3000K		3000		K
<b>Color Temperature</b>	ССТ	I <sub>F</sub> = 1000 mA	3500K		3500		
			4000K		4000		
		5000K		5000			
olor Rendering Index**	CRI	I <sub>F</sub> = 1000 mA		80			
Viewing Angle***	2θ <sub>1/2</sub>	I <sub>F</sub> = 1000 mA			120		degr
Life Time (L <sub>70</sub> )	Т	65C at T <sub>s</sub>			50000		hou

 $<sup>\</sup>ensuremath{^{*}}$  Notes: All measurements were made under the standardized environment of SSC.

<sup>\*\*</sup> CCT is <90 for +4000K boards

<sup>\*\*\*</sup>  $2\theta1/2$  is the off-axis where the luminous intensity is 1/2 of the peak intensity.

<sup>\*\*\*\*</sup> Thermal resistance: RthJS (junction / solder) Tolerance: VF :±0.1V, IV :±7%, Ra :±2, x,y :±0.007





## **ELECTRICAL SPECIFICATIONS - 90 CRI**

Absolute Maximum Ratings (Ta=25C, RH30%)			
Parameter	Symbol	Rating	Unit
DC Input Forward Current *	I <sub>IN</sub>	1500	mA
Power Dissipation	$P_{D}$	50	W
Junction Temperature*	Tj	125	°C
Operating Temperature	Topr	-20 ~ +50	°C
ESD	HBM	5000	V
Storage Temperature	Tstg	-40 ~ +80	°C
Temperature of AI MCPCB** Max.	TS	85	°C

ctrical & Optical Characte	ristics (Ta=25	5C, RH30%)					
Parameter	Symbol	Condition	Model	Min.	Тур.	Max.	Unit
Forward Voltage*	VF	I <sub>F</sub> = 1000 mA		28	30	33	V
			2700K		3300		
			3000K		3600		
Total Flux	ФV	I <sub>F</sub> = 1000 mA	3500K		3750		lm
			4000K		3900		
			5000K		4350		
Efficacy			2700K		110		
		η I <sub>F</sub> = 1000 mA	3000K		120		lm/W
	η		3500K		125		
			4000K		130		
			5000K		145		
			2700K		2700		
			3000K		3000		К
<b>Color Temperature</b>	CCT I <sub>F</sub> = 1000 mA	I <sub>F</sub> = 1000 mA	3500K		3500		
			4000K		4000		
			5000K		5000		
olor Rendering Index**	CRI	I <sub>F</sub> = 1000 mA		90		98	
Viewing Angle***	2θ <sub>1/2</sub>	I <sub>F</sub> = 1000 mA			120		degre
Life Time (L <sub>70</sub> )	Т	65C at T <sub>s</sub>			50000		hour

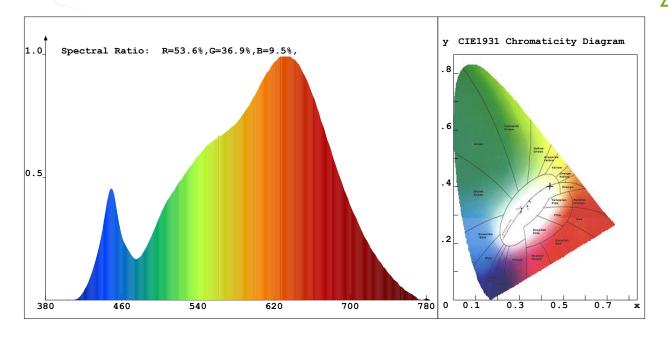
<sup>\*</sup> Notes: All measurements were made under the standardized environment of SSC.

<sup>\*\*</sup> CCT is <90 for +4000K boards

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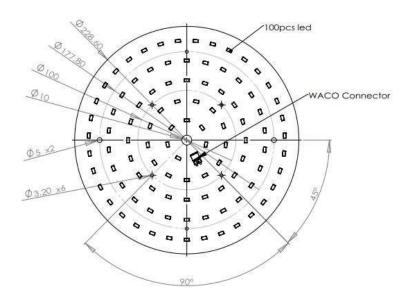
<sup>\*\*\*\*</sup> Thermal resistance: RthJS (junction / solder) Tolerance: VF :±0.1V, IV :±7%, Ra :±2, x,y :±0.007





Recommended LED Drivers							
120V 277V 200-240V Universal							
DA35W1000C	DE35W1000C	DU35W1000C	DS35W1000C				

#### MECHANICAL SPECS.



## CAUTION!

- Turn the power off before installing LED to the proper constant current LED driver.
- Avoid short circuit, or drilling / cutting the LED board! It will damage its electrical circuit!





#### (1) Storage

To avoid the moisture penetration, we recommend store in a dry box

with a desiccant . The recommended storage temperature range is 5C to 30C and a maximum humidity of RH50%.

- (2) Use Precaution after Opening the Packaging as separation of the lens may affect the light output efficiency. Pay attention to the following:
- a. Recommend conditions after opening the package
- Sealing
- Temperature : 5 ~ 40°C Humidity : less than RH30%
- b. If the package has been opened more than 4 week(MSL\_2a) or the color of the desiccant changes, components should be dried for 10-12hr at  $60\pm5$ °C
- (3) Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering.
- (4) Do not rapidly cool device after soldering.
- (5) Components should not be mounted on warped (non coplanar) portion of PCB.
- (6) Radioactive exposure is not considered for the products listed here in.
- (7) Gallium arsenide is used in some of the products listed in this publication. These products are dangerous if they are burned or shredded in the process of disposal. It is also dangerous to
- drink the liquid or inhale the gas generated by such products when chemically disposed of.
- (8) This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA (Isopropyl Alcohol) should be used.
- (9) When the LEDs are in operation the maximum current should be decided after measuring the package temperature.
- (10) LEDs must be stored properly to maintain the device. If the LEDs are stored for 3 months or more after being shipped from SSC, a sealed container with a nitrogen atmosphere should be used for storage.
- (11) The appearance and specifications of the product may be modified for improvement without notice.
- (12) Long time exposure of sunlight or occasional UV exposure will cause lens discoloration.
- (13) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture.

Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues.

- (14) Attaching LEDs, do not use adhesives that outgas organic vapor.
- (15) The driving circuit must be designed to allow forward voltage only when it is ON or OFF.
- If the reverse voltage is applied to LED, migration can be generated resulting in LED damage.